



# P-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)	
	0.066 at V <sub>GS</sub> = - 4.5 V	- 9 <sup>a</sup>		
- 20	0.094 at V <sub>GS</sub> = - 2.5 V	- 9 <sup>a</sup>	6 nC	
	0.130 at V <sub>GS</sub> = - 1.8 V	- 9 <sup>a</sup>		

#### **FEATURES**

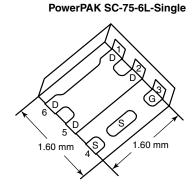
- · Halogen-free
- TrenchFET<sup>®</sup> Power MOSFET
- New Thermally Enhanced PowerPAK<sup>®</sup> SC-75 Package
  - Small Footprint Area
  - Low On-Resistance

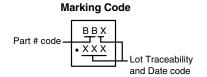


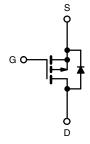
RoHS

#### APPLICATIONS

 Load Switch, PA Switch and Battery Switch for Portable Devices







Ordering Information: SiB411DK-T1-GE3 (Lead (Pb)-free and Halogen-free)

P-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b>	<b>S</b> T <sub>A</sub> = 25 °C, unle	ss otherwise n	oted		
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage	$V_{DS}$	- 20	V		
Gate-Source Voltage	$V_{GS}$	± 8	V		
	T <sub>C</sub> = 25 °C		- 9 <sup>a</sup>		
Continuous Drain Current (T <sub>.1</sub> = 150 °C)	T <sub>C</sub> = 70 °C	1_	- 8.9 <sup>a</sup>		
Continuous Diain Current (1) = 130 C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	- 4.8 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		- 3.8 <sup>b, c</sup>	Α	
Pulsed Drain Current		I <sub>DM</sub>	- 15		
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	I_	- 9 <sup>a</sup>		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	l <sub>S</sub>	- 2 <sup>b, c</sup>		
	T <sub>C</sub> = 25 °C		13	w	
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	P <sub>D</sub>	8.4		
	T <sub>A</sub> = 25 °C	' D	2.4 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		1.6 <sup>b, c</sup>		
Operating Junction and Storage Temperature Ra	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		
Soldering Recommendations (Peak Temperature		260			

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b, f</sup>	t ≤ 5 s	$R_{thJA}$	41	51	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R <sub>thJC</sub>	7.5	9.5	]	

#### Notes:

- a. Package limited.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 5 s
- d. See Solder Profile (http://www.vishay.com/ppg?73257). The PowerPAK SC-75 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under Steady State conditions is 105 °C/W.

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<b>SPECIFICATIONS</b> $T_J = 25$ °C,	<b>SPECIFICATIONS</b> T <sub>J</sub> = 25 °C, unless otherwise noted						
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 20			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$ $\Delta V_{GS(th)}/T_{J}$	J 050 A		- 18		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient		I <sub>D</sub> = - 250 μA		2.2			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu\text{A}$	- 0.4		- 1	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA	
Zero Ceta Valtaga Dusia Cumant		V <sub>DS</sub> = - 20 V, V <sub>GS</sub> = 0 V			- 1	μΑ	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ = - 20 V, $V_{GS}$ = 0 V, $T_J$ = 55 °C			- 10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le 5 \text{ V}, V_{GS} = -4.5 \text{ V}$	15			Α	
Drain-Source On-State Resistance <sup>a</sup>		$V_{GS} = -4.5 \text{ V}, I_D = -3.3 \text{ A}$		0.055	0.066	1	
	R <sub>DS(on)</sub>	$V_{GS} = -2.5 \text{ V}, I_D = -2.8 \text{ A}$		0.077	0.094	Ω	
		V <sub>GS</sub> = - 1.8 V, I <sub>D</sub> = - 0.77 A		0.107	0.130		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = -10 \text{ V}, I_{D} = -3.3 \text{ A}$		9.5		S	
Dynamic <sup>b</sup>				•		•	
Input Capacitance	C <sub>iss</sub>			470		pF	
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz		95			
Reverse Transfer Capacitance	C <sub>rss</sub>			65			
T. 10 . 0	Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = - 8 V, I <sub>D</sub> = - 4.5 A		10	15	nC	
Total Gate Charge		V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 4.5 A		6	9		
Gate-Source Charge				0.9			
Gate-Drain Charge				1.4			
Gate Resistance	$R_g$	f = 1 MHz		7.5		Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			10	15		
Rise Time	t <sub>r</sub>	$V_{DD} = -10 \text{ V}, R_L = 2.1 \Omega$		40	60	1	
Turn-Off Delay Time		$I_D\cong$ - 4.8 A, $V_{GEN}$ = - 4.5 V, $R_g$ = 1 $\Omega$		45	70		
Fall Time	t <sub>f</sub>			75	115		
Turn-On Delay Time	Delay Time $t_{d(on)}$			5	10	ns	
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 10 V, $R_L$ = 2.1 $\Omega$		10	15		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ - 4.8 A, $V_{GEN}$ = - 8 V, $R_g$ = 1 $\Omega$		25	40	- -	
Fall Time	t <sub>f</sub>			10	15		
Drain-Source Body Diode Characteristi	cs			•		•	
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			- 9	^	
Pulse Diode Forward Current	I <sub>SM</sub>				15	A	
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = - 3.8 A, V <sub>GS</sub> = 0 V		- 0.85	- 1.2	V	
Body Diode Reverse Recovery Time t <sub>rr</sub>				20	40	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = - 3.8 A, di/dt = 100 A/μs, T <sub>J</sub> = 25 °C		10	20	nC	
Reverse Recovery Fall Time	t <sub>a</sub>			15		ns	
Reverse Recovery Rise Time	t <sub>b</sub>			5			

#### Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$ 

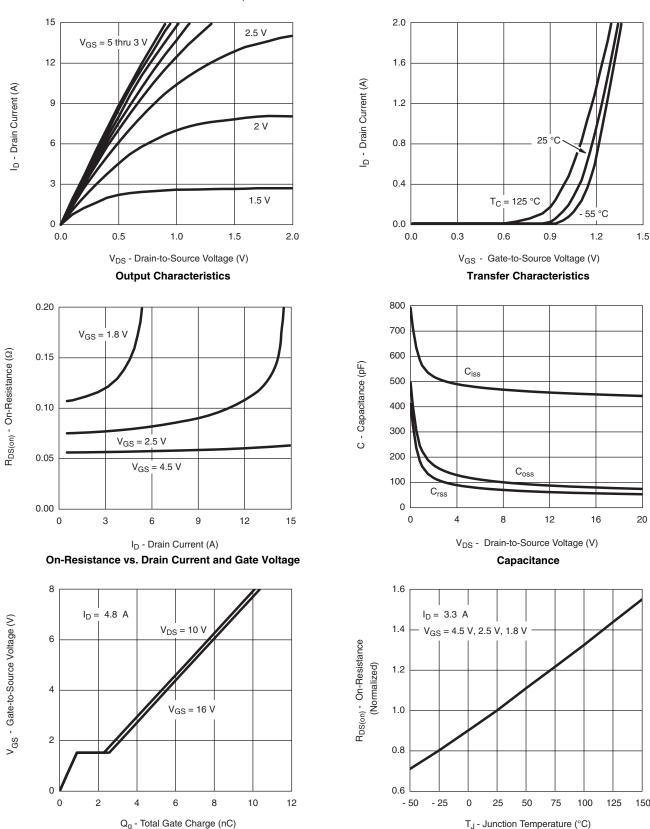
b. Guaranteed by design, not subject to production testing.







## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



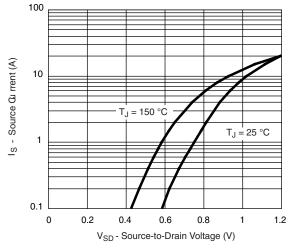
**Gate Charge** 

On-Resistance vs. Junction Temperature

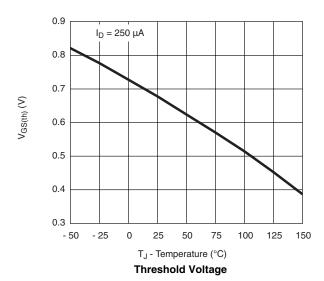
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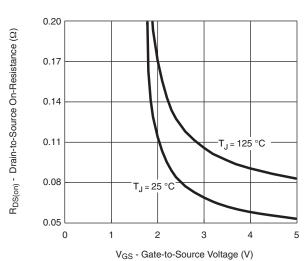
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## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

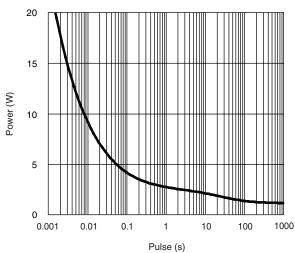


#### Soure-Drain Diode Forward Voltage

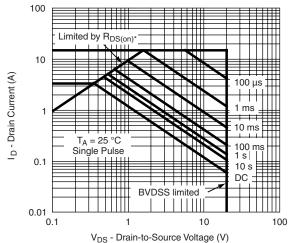




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



\*  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

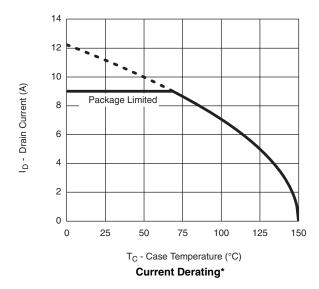
Safe Operating Area, Junction-to-Case

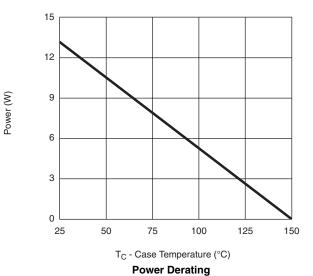






## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





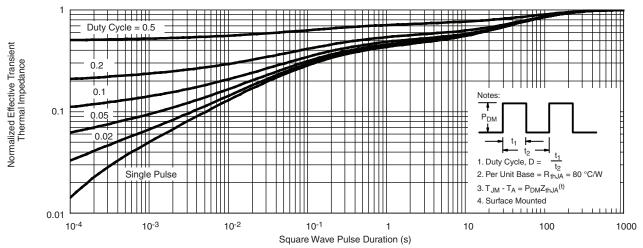
Document Number: 74335 S-80515-Rev. C, 10-Mar-08

<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

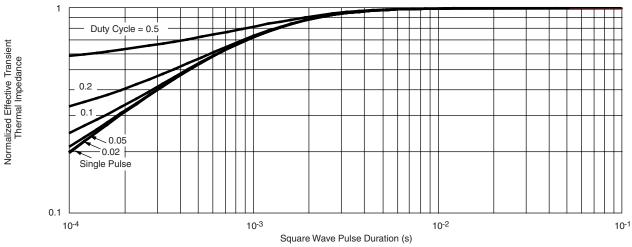
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## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



#### Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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